EAST Search History

Ref #	Hits	Search Query	DBs	Default Operat or	Plural s	Time Stamp
L1	9042	((hydrogen "H.sub.2") same plasma same (core conductive metal copper Cu))	US-PGPU B; USPAT; USOCR	OR	ON	2006/10/10 09:16
L2	9042	((hydrogen "H.sub.2") same plasma same (core conductive metal copper Cu))	US-PGPU B; USPAT; USOCR	OR	ON	2006/10/10 09:50
L3	3358	2 and (silver "Ag" gold "Au")	US-PGPU B; USPAT; USOCR	OR	ON	2006/10/10 09:51
L4	2302	3 and semiconductor	US-PGPU B; USPAT; USOCR	OR	ON	2006/10/10 09:17
L5	2228	4 and (trench via hole recess ompen\$3 groove contact)	US-PGPU B; USPAT; USOCR	OR	ON	2006/10/10 09:51
L6	330	5 and (seed near5 (film layer))	US-PGPU B; USPAT; USOCR	OR	ON	2006/10/10 09:19
L7	3144	((hydrogen "H.sub.2") and plasma and (core conductive metal copper Cu))	FPRS; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/10/10 09:51
L8	600	7 and (silver "Ag" gold "Au")	FPRS; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/10/10 09:51
L9	105	8 and (trench via hole recess ompen\$3 groove contact)	FPRS; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/10/10 09:51